

This document is only an extract of the datasheet which can be provided by Infineon in its full version upon request

Features

- · Several PSI5-modes selectable by EEPROM bit
- Transmission of temperature and p₀ pressure information via PSI5 i/f during normal operation
- Two pressure ranges selectable by EEPROM bit
- Transmission of two $\Delta p/p_0$ values with different sensitivities in two time slots
- ISO 26262 Safety Element out of Context for safety requirements up to ASIL B(D)
- Compatible to AK-LV 29 and AK-LV 38
- · Compatible to the AK-LV 38 addendum with extended measurement range
- End-of-line EEPROM programming via PSI5 interface
- EEPROM for ID number, calibration and mode selection
- Relative pressure signal (Δp/p₀-signal)
- Application compatible to KP20x and KP30x









Potential applications

Pressure sensor for side crash, pedestrian impact and front crash detection

Product validation

Product validation according to AEC-Q100 (Grade 1) and AEC-Q103-002 (Grade M1). Qualified for automotive applications.

Description

The device is a pressure sensor for the detection of side crashes in passenger cars and for other pressure based collision detection systems like pedestrian or front crash protection. In these applications the pressure sensor is assembled in a door module located within the car's side door or connected to an other crash sensitive air volume like a tube in the bumper of the car. When the air volume is compressed due to the collision, the device provides an output, which is proportional to the pressure change inside the sensitive air volume ($\Delta p/p_0$). The amplitude of the output is independent of the ambient pressure but is dependent on the relative pressure change. The device provides the relative pressure as a digital Manchester encoded output signal. This cost optimized configuration allows autonomous operation of the sensor without any further logic ICs in the pressure satellite.

Product type	Package	Marking	Ordering code
KP405	PG-DFN-8-1	KP405	SP005414529

Technical product description



Table of contents

Table of contents

1 Product description 1.1 Functional safety features 1.2 Operating modes 2 Pin configuration 3 General product characteristics 3.1 Absolute maximum ratings 3.2 Operating conditions 3.3 Electrical characteristics 3.3.1 Power supply and micro break circuitry	. 4 5 6 6 7
1.2 Operating modes 2 Pin configuration 3 General product characteristics 3.1 Absolute maximum ratings 3.2 Operating conditions 3.3 Electrical characteristics	4 . 5 . 6 7 8
Pin configuration General product characteristics Absolute maximum ratings Operating conditions Electrical characteristics	. 5 . 6 7 8
General product characteristics 3.1 Absolute maximum ratings 3.2 Operating conditions 3.3 Electrical characteristics	. 6
3.1 Absolute maximum ratings	. 6 7 8
3.2 Operating conditions	7 8 . 8
3.3 Electrical characteristics	8
	. 8
3.3.1 Power supply and micro break circuitry	
3.3.2 Data range and accuracy	.10
3.3.3 Digital core and signal path filter	13
3.3.4 PSI5 interface	. 14
3.3.5 EEPROM and load characteristics	
4 Functional block description	20
4.1 PSI5 interface: Sensor-to-ECU communication	. 20
4.1.1 Physical layer	.20
4.1.1.1 Synchronous communication	
4.1.1.2 Synchronization pulse detection	21
4.1.1.3 Asynchronous communication	. 23
4.1.2 Data link layer	23
4.1.2.1 PSI5 protocols	. 23
4.1.2.2 Data protocol (10-bit format)	.24
4.1.2.2.1 Data range	. 24
4.1.2.3 Data protocol (16-bit format)	.26
4.1.2.3.1 CRC calculation	
4.1.2.3.2 Data range scaling	. 27
4.1.2.3.3 Data range	. 27
4.1.3 PSI5 interface application layer	
4.1.3.1 Phase 1	. 29
4.1.3.2 Phase 2	. 29
4.1.3.2.1 Identification data content	29
4.1.3.3 Phase 3	. 30
4.1.3.3.1 Ambient pressure transmission structure	31
4.1.3.4 Phase 4	
4.1.3.5 Error sequence	32
4.2 Micro break functionality	
4.3 Test modes	

Technical product description



Table of contents

5	Application information	32
5.1	Potential target applications	34
5.2	Application circuit example	34
5.3	Electro magnetic compatibility (EMC)	34
6	Package information	35
6.1	Package outline	35
6.2	Package footprint drawing	
6.3	Pick and place info	36
6.3.1	Component placement	36
6.4	Identification code	37
7	References	38
8	Revision history	39
	Disclaimer	40



1 Product description

1 Product description

1.1 Functional safety features

Several functional safety features are implemented by the device to ensure safe operation in the respective applications.

1.2 Operating modes

The device supports the following operating modes and can be selected by EEPROM.

Table 1 Definition of valid operating modes

Mode	Dynamic range	Sensitivity	Available protocols	p ₀ range	p ₀ or T _j transmission	
Mode 1	-5 +15%	20.48 LSB/%	P10P-500/3L	45.5 110 kPa	no	
			P10P-500/4H			
			P16CRC-500/3H			
			P16CRC-500/2L			
Mode 2	-15 +23.4%	20.48 LSB/%	P10P-500/3L	45.5 110 kPa	in additional time	
			P10P-500/4H	45.5 140 kPa	slot	
			P16CRC-500/3H			
			P16CRC-500/2L			
			P10P-250/1L			
			P10P-250/2H			
			A10P-250/1L			
Mode 3	-15 +23.4%	20.48 LSB/%	P10P-500/3L	45.5 110 kPa	in additional time	
	-15 +100%	4.80 LSB/%	P10P-500/4H	45.5 140 kPa	slot	
			transmission in different time slots			
Mode 4	-15 +100%	20.48 LSB/%	P16CRC-500/3H	45.5 110 kPa	in additional time	
			P16CRC-500/2L	45.5 140 kPa	slot	

Note:

- The parameters "Dynamic range" (clipping limits) and "Sensitivity" are linked with the selected operating mode.
- Only the here specified protocols in combination with the operating modes are allowed and verified. For maximum number of allowed time slots refer to section "PSI5 protocols" in datasheet (Rev. 1.10), 2024-08-23
- For some operating modes with additional time slots, the maximum supply voltage VDD is reduced. For details see Table 4.



2 Pin configuration

2 Pin configuration

The figure below shows the pin configuration.

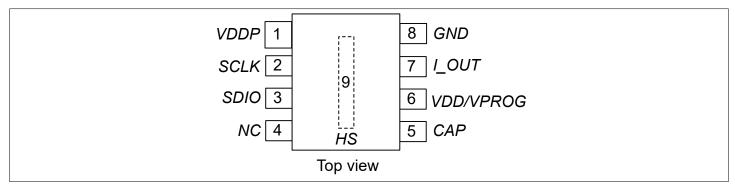


Figure 1 Pin configuration (PG-DFN-8-1)

The table below shows the pin description.

Table 2 Pin description

Pin No.	Symbol	Function	Comment
1	VDDP	power supply for serial i/f drivers	+5V, internal pull down
2	SCLK	serial interface clock	internal pull up
3	SDIO	input and output pin for serial interface	internal pull up
4	NC	not connected	
5	CAP	buffer capacitance	optional
6	VDD/VPROG	supply voltage / EEPROM Programming voltage	-
7	I_OUT	current modulator output	-
8	GND	sensor ground	-
9	HS	heat sink	on bottom side of package

Note: Pins 1 ... 4 must be kept on a floating potential in the application.

Pin 9 must be kept on a floating potential and it must not be soldered to the PCB. For that purpose a keep-out area shall be placed around the heat sink during board design (see Chapter 6.2).

Technical product description



3 General product characteristics

3 General product characteristics

3.1 Absolute maximum ratings

Table 3 Absolute maximum ratings

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Voltage on VDD	V_{DD}	-16.5	_	24	V	$ V_{DD} - V_{iout} \le 24 \text{ V}$	REQ-2581
Voltage on I_OUT	V _{iout}	-16.5	_	24	V	V _{DD} - V _{iout} ≤ 24 V	REQ-2582
Voltage on CAP	V _{CAP}	-16.5	_	24	V	$ V_{DD} - V_{iout} \le 24 \text{ V}$	REQ-2583
Voltage on serial pins (VDDP, SCLK, SDIO, NC)	$V_{ m dig_pin}$	-0.3	-	5.5	V		REQ-2584
Current on serial pin (SCLK, SDIO)	I _{dig_out}	_	-	0.1	mA		REQ-2585
Supply current on VDDP pin	I _{VDDP}	_	-	1	mA		REQ-2586
Maximum operating temperature	T _{Op_max}	-	-	135	°C	time limited for 30 minutes maximum	REQ-2587
Ambient storage temperature	T _{st}	-55	_	135	°C		REQ-2588
Input pressure range	P _{range}	10	-	300 600 *)	kPa kPa	*) limited time: max. 300 s	REQ-2589
ESD robustness according to Human Body Model (HBM) HV-pins: VDD, GND, I_OUT, CAP	V _{ESD-HV}	-	-	4	kV	according to ANS/ ESDA/ JEDEC JS-001	REQ-2590
ESD robustness according to Human Body Model (HBM) LV-pins: VDDP, SCLK, SDIO, NC	V _{ESD-LV}	-	-	2	kV	according to ANS/ ESDA/ JEDEC JS-001	REQ-2591
Latch-up robustness for each pin	I _{latchup}	±100	-	-	mA	according to EIA/ JESD78	REQ-2592
Lid pull-off force	F _{pull_off_lid}	1	-	-	N	only valid at 0h and during module assembly	REQ-2593
Lid push-in force	F _{push_in_lid}	-	-	10	N	max. allowed force on top of the lid without damaging the sensor	REQ-2594

Technical product description



3 General product characteristics

Table 3 (continued) Absolute maximum ratings

Parameter	Symbol Values				Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Mechanical shock survival	g _{st}	-6000	_	6000	g	unpowered, 0.3 ms	REQ-2595
Differential pressure between inside and outside of package	p _{diff}	-90		300	kPa	the minimum absolute pressure of p_{range} must not be violated	REQ-2596

Attention:

Stresses above the max. values listed in this chapter may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

3.2 Operating conditions

Table 4 Operating conditions

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Supply voltage at pin VDD	V _{DD}	4.5	-	11.0	V	V _{DD_max} = 9V for operation in triple slot mode with P10P-500/3L;	REQ-2598
						V _{DD_max} = 8.4V for operation in dual slot mode with P16CRC-500/2L	
Voltage at pin I_OUT	V _{iout}	3.5	_	11.0	V		REQ-2600
Voltage at pin CAP	V _{CAP}	-	_	V _{sync}	V	pin only defined to connect with a capacitor; connection with a constant voltage source not allowed	REQ-2602
Voltage during sync pulse at pin VDD & pin I_OUT	V _{sync}	-	_	16.5	V		REQ-2603
Supply voltage power up/down gradient	V _{grad}	1E-5	_	1E4	V/ms		REQ-2604
Ambient operating temperature	T _{Op}	-40	-	125	°C	temperature outside the sensor	REQ-2606

Technical product description



3 General product characteristics

Table 4 (continued) Operating conditions

Parameter	Symbol		Values		Unit	Note or condition	P-
		Min.	Тур.	Max.			Number
Absolute operating pressure range	p _{abs}	38.7	-	280.0	kPa	range for pressure pulses during a crash	REQ-2610
Ambient operating pressure for p0-range1	p _{amb_1}	45.5	_	110.0	kPa	range for p ₀ value in p ₀ -range1	REQ-2611
Ambient operating pressure for p0-range 2	p _{amb_2}	45.5	_	140.0	kPa	range for p ₀ value in p ₀ -range2	REQ-2612
Lifetime	t _{live}	15	_	_	years		REQ-2613
Operating time 1	t _{Op_1}	-	-	12000	h	valid for temperature mission profile as specified in AK LV29 (SAB) [4]	REQ-2614
Operating time 2	t _{Op_2}	-	-	8000	h	valid for temperature mission profile as specified in AK LV38 (PED PRO) [5]	REQ-2615

Note:

Outside the normal operation supply voltage range the overvoltage detection disables the Manchester communication. As long as the overvoltage detection has not detected an overvoltage, the sensor operates inside the specified operating range.

Attention: The device is sensitive to light entering through the pressure port. All specifications are valid for a illuminance of less than 1 lx.

3.3 Electrical characteristics

Product characteristics involve the spread of values ensured within the specified voltage and ambient temperature range. Typical characteristics are the median of the production.

3.3.1 Power supply and micro break circuitry

Table 5 Power supply and micro break circuitry

Parameter	Symbol		Values			Note or	P-
		Min.	Тур.	Max.		condition	Number
Supply current into VDD	I _{VDD}	3.5	_	5.5	mA		REQ-2617
Supply current into I_OUT	I _{I_OUT_idle}	0.0	_	0.8	mA		REQ-2618
Common supply current into VDD & I_OUT	l _{idle}	4.0	-	6.0	mA		REQ-2619

Technical product description



3 General product characteristics

Table 5 (continued) Power supply and micro break circuitry

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Current during Manchester communication	I _{Man}	26	31	36	mA	$I_{Man} = I_{idle} + \Delta I_{mod}$	REQ-2620
Ripple current on supply voltage	I _{ripple}	-0.5	_	0.5	mA	0 Hz - 2 MHz; I _{ripple} is max AC amplitude and only valid with application circuit	REQ-2622
Supply current drift rate	l _{idle_drift}	-	-	1.0	mA/s	characterized by the average of minimum 1s	REQ-2623
Voltage level for activating micro break function	$V_{\mu b}$	3.1	_	4.1	V		REQ-2628
Microcut rejection time	t _{CAP}	10	-	-	μs	Time below Vµb where no sensor reset is allowed; C _{buf} > 100 nF	REQ-2630
Micro break hysteresis	V _{µb_hys}	0.4	-	0.9	V	application resistors: 47 Ω ±5%	REQ-2631
Load resistor for Cbuf	R _{CAP}	1.4	2.0	2.6	kΩ	resistor value between VDD and CAP pin	REQ-2633
External buffer capacitor	C _{buf}	0	-	1	μF	no capacitor needed to avoid oscillation of regulator; 1)	REQ-2634
Allowed range for Cbuf to pass buffer-cap-diagnosis-test	C _{buf_test}	33	-	C _{buf}	nF	VDD = 6 V; CAP- pin discharged to GND before start- up; At values below, buffer-cap- diagnosis-test might diagnose a missing C _{buf}	REQ-2636

 $^{^{1)}}$ If a capacitor value below $C_{buf_test_min}$ is used, the buffer-cap-diagnosis-test must be disabled in EEPROM; a value larger than given here can lead to a violation of the PSI5 specification parameter t_{Th} ;

Technical product description



3 General product characteristics

3.3.2 Data range and accuracy

Table 6 Data range and accuracy

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Nominal measurement range1 (Mode 1)	range _{nom1}	-5.0	-	+15.0	%	outside the specified nominal measurement range the output value is clipped	REQ-2637
Nominal measurement range2 (Mode 2)	range _{nom2}	-15.0	-	+23.4	%	outside the specified nominal measurement range the output value is clipped	REQ-2638
Nominal measurement range3 (Mode 3 or Mode 4)	range _{nom3}	-15.0	_	+100	%	outside the specified nominal measurement range the output value is clipped	REQ-2639
Δp/p0 output data range1 (Mode 1)	Δp/p _{0_dat1}	-102	_	307	LSB	outside this defined output data range the output value is clipped	REQ-2640
Δp/p0 output data range2 (Mode 2 and Mode 3-slot1)	Δp/p _{0_dat2}	-307	-	480	LSB	outside this defined output data range the output value is clipped	REQ-2641
Δp/p0 output data range3 (Mode 3-slot2)	Δp/p _{0_dat3}	-72	-	480	LSB	outside this defined output data range the output value is clipped	REQ-2642
Δp/p0 output data range4 (Mode 4)	Δp/p _{0_dat4}	-307	-	2048	LSB	outside this defined output data range the output value is clipped	REQ-2643
Nominal sensitivity1 (Mode 1, Mode 2, Mode 3- dp/p0_1, Mode 4)	sense _{out1}	-	2.048	-	LSB/‰	output signal $\Delta p/p_0$	REQ-2645

Technical product description



3 General product characteristics

Table 6 (continued) Data range and accuracy

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Nominal sensitivity2 (Mode 3-dp/p0_2)	sense _{out2}	-	0.480	-	LSB/‰	output signal $\Delta p/p_0$ in additional time slot	REQ-2646
Pressure data offset	$\Delta p/p_{0_{-}off}$	-0.5	_	0.5	LSB	average value at constant pressure	REQ-2647
Sensitivity error at 0h	sense _{err1_0h}	-6.0	_	+6.0	%	Δp/p ₀ > 10.0% (over full temperature range)	REQ-2648
Sensitivity error over lifetime (-40°C +105°C)	sense _{err}	-7.0	-	+7.0	%	Δp/p ₀ > 10.0%; (overall sensitivity error: incl. temperature, non-linearity etc.)	REQ-2650
Sensitivity error over lifetime (+105° +125°C)	sense _{err_HT}	-10.0	-	+10.0	%	Δp/p ₀ > 10.0%; (overall sensitivity error: incl. temperature, non-linearity etc.)	REQ-2651
Δp/p0 noise (RMS) (sensitivity1, p0 = 53.6 110 kPa)	noise _{rms,1}	0	-	1.5	LSB	standard deviation of Δp/p ₀ at constant pressure (e.g. 99.7% of the values inside the ±4.5 LSB range)	REQ-2652
Δ p/p0 noise (RMS) (sensitivity1, p0 = 45.5 53.6kPa)	noise _{rms,1_LP}	0	-	2.0	LSB	standard deviation of Δp/p ₀ at constant pressure (e.g. 99.7% of the values inside the ±6 LSB range)	REQ-2653
Δp/p0 noise (Peak)	noise _{peak,1}	-6	-	+6	LSB	during characterization only: Peak value for 10k samples; 0h & 25°C, sensitivity1	REQ-2654

Technical product description



3 General product characteristics

Table 6 (continued) Data range and accuracy

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Δp/p0 noise (RMS) (sensitivity2)	noise _{rms,2}	0	-	0.5	LSB	standard deviation of Δp/p ₀ at constant pressure (e.g. 99.7% of the values inside the ±1.5 LSB range)	REQ-2655
Non-linearity for pressure pulses up to 23.4%	sense _{n_lin1}	-1.0	-	+1.0	%0	difference between actual characteristics and best fit quantized line	REQ-2656
Non-linearity for pressure pulses > 23.4%	sense _{n_lin2}	-2.5	-	+2.5	%0	difference between actual characteristics and best fit quantized line	REQ-2657
Pressure offset during acceleration	P _{acc}	-	_	3.5	Pa/g	ensured by design	REQ-2658
p0 data output range in Phase 4	P _{0_word_p4_lim}	0	_	480	LSB	outside this defined pressure data range the output value is clipped	REQ-2660
p0 data transmission sensitivity (p0 range1)	p _{0_sens_r1}	_	0.01868	-	kPa/LSB	valid for Phase 3 and Phase 4	REQ-2661
p0 data transmission sensitivity (p0 range2)	p _{0_sens_r2}	-	0.02310	_	kPa/LSB	valid for Phase 3 and Phase 4	REQ-2662
p0 data transmission offset	p _{0_offset}	-	50	-	kPa	valid for Phase 3 and Phase 4	REQ-2663
p0 data error (p0 range1)	p _{0_err1}	-3.5	-	3.5	kPa	valid for Phase 3 and Phase 4	REQ-2664
p0 data error (p0 range2)	p _{0_err2}	-3.5	-	3.5	kPa	valid for Phase 3 and Phase 4	REQ-2665
Tj data output range in Phase 4	T _{word_p4_lim}	-425	-	-70	LSB ₁₀	outside this defined temperature data range the output value is clipped	REQ-2667
Tj data transmission sensitivity	T _{j_sens}	_	0.61162	_	°C/LSB	valid for Phase 3 and Phase 4	REQ-2668

Technical product description



3 General product characteristics

Table 6 (continued) Data range and accuracy

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Tj data transmission offset	T _{j_offset}	-	-94	-	°C	valid for Phase 3 and Phase 4	REQ-2669
Tj error (Tj = 0°C 100°C)	T _{j_err}	-5	-	+5	°C	valid for Phase 3 and Phase 4	REQ-2670
Tj error (Tj < 0°C; Tj > 100°C)	T _{j_err2}	-10	-	10	°C	valid for Phase 3 and Phase 4	REQ-2671

3.3.3 Digital core and signal path filter

Table 7 Digital core and signal path filter

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Internal clock frequency	f _{clk}	_	16.0	_	MHz		REQ-2676
Clock variation	CLK _{tol}	-4.0	_	4.0	%		REQ-2677
Clock variation during Manchester frame	CLK _{var/frame}	-	-	0.1	%	maximum allowed temperature gradient is +/- 1 K/min	REQ-2678
Clock drift rate	CLK _{drift}	-	-	1.0	%/s	average of min. 1s; maximum allowed temperature gradient is +/-1 K/min	REQ-2679
Sigma delta sample frequency	f _{cic}	-	1	_	MHz	average over 1 second	REQ-2680
p & p0 register update	f _{preg}	-	31.25	_	kHz	proportional to clock frequency	REQ-2681
Cut-off frequency p filter	f _{cp}	-	370	_	Hz	2 nd order low pass filter	REQ-2682
						proportional to clock frequency	
p0 filter gradient	$ \Delta p_0/\Delta t $	0.39	0.44	0.49	kPa/s		REQ-2685

Technical product description



3 General product characteristics

3.3.4 PSI5 interface

Table 8 PSI5 interface

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Bit time in 125 kbps mode	t _{Bit}	-	8.0	_	μs	proportional to clock frequency	REQ-2687
Bit time in 189 kbps mode	t _{Bit_H}	-	5.3	-	μs	proportional to clock frequency	REQ-2688
Signal modulation current	ΔI_{mod}	22	26	30	mA		REQ-2689
Fall/rise time current slope	t _{Man_R/F}	0.33	-	1.0	μs	t _{rise 20, 80} & t _{fall 80, 20} , according to the PSI5 reference network, the PSI5 sensor reference tests conditions A & B [1] and the application circuit example	REQ-2691
Duty cycle ratio Manchester	r _{Man_duty}	47	50	53	%	(t _{fall,80} - t _{rise,20}) / t _{Bit} (t _{fall,20} - t _{rise,80}) / t _{Bit} according to the PSI5 reference network, the PSI5 sensor reference tests conditions A [2] and the application circuit example	REQ-2692
Sync pulse detection threshold	V _{trig}	1.4	2.0	2.6	V	The absolute sync pulse detection voltage is calculated by adding V _{trig} to the supply voltage V _{idle} (see Chapter 4.1.1.2)	REQ-2693

Technical product description



3 General product characteristics

Table 8 (continued) PSI5 interface

Parameter	Symbol		Values		Unit	Note or condition	P- Number
		Min.	Тур.	Max.			
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/3L slot1 mode	t _{Slot1,frame}	44.1	46.4	48.7	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (ttol_detect) is not included in this timing.	REQ-2704
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/3L slot2 mode	t _{Slot2,frame}	181.3	190.9	200.4	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2705
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/3L slot3 mode	t _{Slot3,frame}	328.9	346.3	363.6	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2706
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-250/1L mode	t _{Slot,frame}	71.4	75.2	78.9	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (ttol_detect) is not included in this timing	REQ-2707

Technical product description



3 General product characteristics

Table 8 (continued) PSI5 interface

Parameter	Symbol		Values		Unit	Note or condition	P-
		Min.	Тур.	Max.			Number
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-250/2H slot1 mode	t _{2H_Slot1,frame}	44.1	46.4	48.7	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (ttol_detect) is not included in this timing	REQ-2708
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-250/2H slot2 mode	t _{2H_Slot2,frame}	141.0	148.4	155.8	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2709
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/4H slot1 mode	t _{4H_Slot1,frame}	44.1	46.4	48.7	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2710
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/4H slot2 mode	t _{4H_Slot2,frame}	139.5	146.9	154.2	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2711

Technical product description



3 General product characteristics

Table 8 (continued) PSI5 interface

Parameter	Symbol		Values		Unit	Note or condition	P-
		Min.	Тур.	Max.			Number
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/4H slot3 mode	t _{4H_Slot3,frame}	245.5	258.4	271.4	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2712
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P10P-500/4H slot4 mode	t _{4H_Slot4,frame}	362.5	381.6	400.7	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2713
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P16CRC-500/3H slot1 mode	t _{3H_Slot1,frame}	44.5	46.4	48.3	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2714
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P16CRC-500/3H slot2 mode	t _{3H_Slot2,frame}	183.2	190.9	198.5	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2715

Technical product description



3 General product characteristics

Table 8 (continued) PSI5 interface

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P16CRC-500/3H slot3 mode	t _{3H_} Slot3,frame	332.4	346.3	360.1	μs	1st Manchester bit starts with nom. 2.65µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2716
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P16CRC-500/2L slot1 mode	t _{2L_Slot1,frame}	44.1	46.4	48.7	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2717
Time between detected rising edge of sync pulse and start of 1st Manchester bit in the PSI5-P16CRC-500/2L slot2 mode	t _{2L_Slot2,frame}	252.8	266.1	279.4	μs	1st Manchester bit starts with nom. 4µs low time; the trigger detection tolerance (t _{tol_detect}) is not included in this timing	REQ-2718
Transmission rate in asynchronous mode	t _{async}	-	228.0	_	μs	proportional to clock frequency	REQ-2719
Filter sample time before start of frame for time slot 1	t _{filter_freeze1}	_	32	-	μs	proportional to clock frequency; valid for 1 st slot transmission in PSI5-P10P-500/3L and PSI5- P10P-500/4H modes only	REQ-2720
Filter sample time before start of frame for time slot 2 and 3 and 4	t _{filter_freeze}	-	40	-	μs	proportional to clock frequency	REQ-2721
Gap time in 125kHz modes	t _{GAP_L}	8.4	-	-	μs	proportional to clock frequency	REQ-2722

Technical product description



3 General product characteristics

Table 8 (continued) PSI5 interface

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
Gap time in 189kHz modes	t _{GAP_H}	5.6	_	-	μs	proportional to clock frequency	REQ-2723
Trigger detection tolerance	t _{tol_detect}	0	-	3	μs		REQ-2724
Duration of phase 1	t _{P1}	90.0	_	110.0	ms		REQ-2725
Duration of phase 2a	t _{P2a}	_	256	_	frame		REQ-2726
Duration of phase 2b	t _{P2b}	0	_	768	frame		REQ-2727
Duration of phase 3a	t _{P3a}	-	5	_	frame		REQ-2728
Duration of phase 3b	t _{P3b}	-	14	_	frame		REQ-2729
Repetition of ID data	k	_	4	_			REQ-2730
Time threshold for the sensor to declare a gap	t _{sync_max}	-	576	-	μs	proportional to clock frequency	REQ-2731

3.3.5 **EEPROM** and load characteristics

Table 9 EEPROM and load characteristics

Parameter	Symbol		Values		Unit	Note or	P-
		Min.	Тур.	Max.		condition	Number
No. of EEPROM programming cycles	n _{prog}	-	-	3	-	a programming cycle is defined as applying the programming pulse once in order to change the state of at least one EEPROM cell	REQ-2736
Programming temperature	T _{prog}	10	_	30	°C		REQ-2741
Margin voltage "1"	V _{margin_1}	-	0	0.25	V	0h value, directly after programming	REQ-2742
Margin voltage "0"	V _{margin_0}	2.0	-	5.0	V	0h value, directly after programming	REQ-2743



4 Functional block description

4 Functional block description

4.1 PSI5 interface: Sensor-to-ECU communication

The physical link between ECU and the satellites is a two-wire, twisted pair connection according to the PSI5 standard ([2] and [3]). It provides the supply voltage to the satellite and is also used for the data transmission between the satellite and the ECU.

The communication between satellite and ECU can be unidirectional (asynchronous communication) or bidirectional (synchronous communication).

4.1.1 Physical layer

For data transmission from the sensor to the ECU, a Manchester-coded current modulation is used.

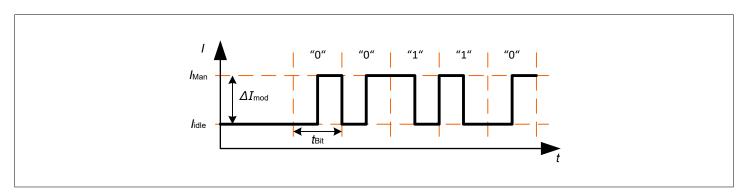


Figure 2 Manchester based current modulation

4.1.1.1 Synchronous communication

In the synchronous communication mode a short voltage pulse (sync pulse), generated by the receiver, is used as a synchronization event. The sensor detecting this sync pulse starts its data transmission after a defined period of time. This operation mode supports more than one satellite per physical channel.

If the sensor is configured to synchronous mode, synchronization pulses from the ECU are expected. In synchronous mode the sensor only transmits the data message after recognizing a sync pulse.

In PSI5-P10P-500/3L mode for example, the sensor can transmit the Manchester frames in the 1^{st} , 2^{nd} or 3^{rd} slot ($t_{Slot1,frame}$, $t_{Slot2,frame}$, $t_{Slot3,frame}$).



4 Functional block description

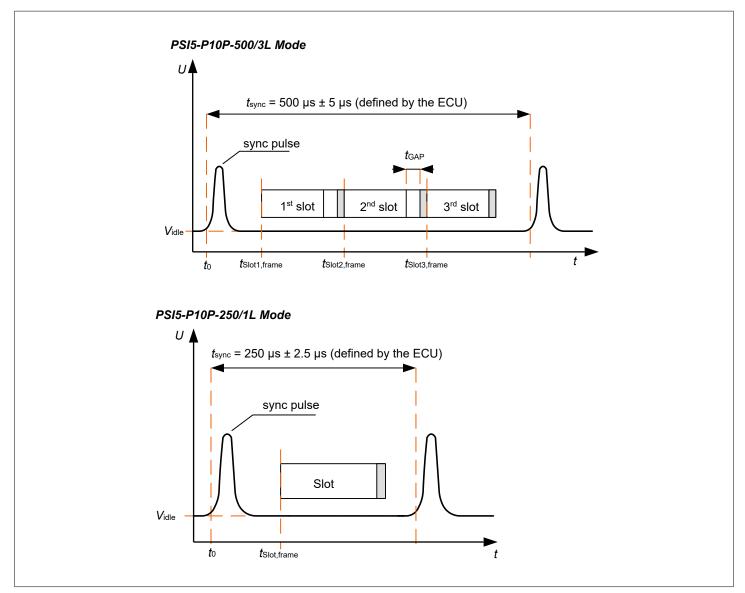


Figure 3 Timing in synchronous mode

4.1.1.2 Synchronization pulse detection

The externally generated synchronization pulse is detected by the integrated sync pulse detection circuit. The output of a comparator, which is part of the sync pulse detection circuit, provides a digital signal whether a valid synchronization pulse voltage is detected or not.

This digital signal is sampled at the time when the rising edge of the synchronization pulse is inside the sync pulse detection window and has a delay of t_{tol_detect} .

Figure 4 shows the time correlation of the PSI5 output to the sync pulse.

The trigger detection time T_{TRIG} on system level is determined by adding up the sensors trigger detection tolerance t_{tol} detect and the contributions from the system, as defined in the PSI5 specification [2].

Note: The system contributions to the trigger detection time T_{TRIG} are not shown in Figure 4.



4 Functional block description

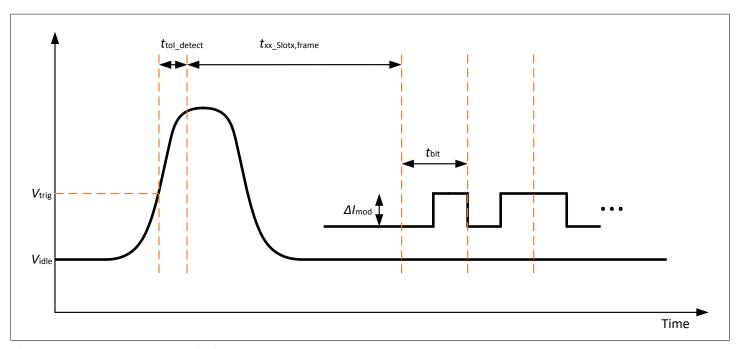


Figure 4 PSI5 slot timing

After detecting the rising edge of a sync pulse the sensor observes the voltage level of the synchronization pulse for n_{sync_det} samples with a sampling frequency of f_{sync_sampl} . If the sample voltage observed is above the specified sync pulse detection threshold V_{trig} an up-counter is incremented by "1". If the line voltage is less than the detection threshold voltage V_{trig} the counter is not incremented. After n_{sync_det} samples the status of the up-counter is readout. Only if the counter is inside the n_{sync_detval} range, a valid sync pulse is detected. Otherwise no sync pulse will be detected and the up-counter will be reset.

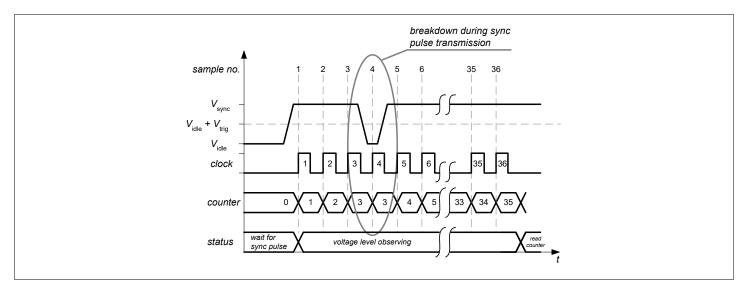


Figure 5 Sync pulse counter functionality

If a valid sync pulse is detected then a Manchester frame is sent out in the programmed time slot. During this time $(t_{sync\ off\ xxx})$ no further sync pulses can be detected.

A sync pulse of minimum 9µs in normal duration is recommended.



4 Functional block description

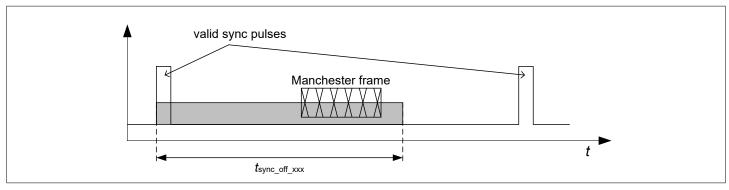


Figure 6 Sync pulse detection off time

4.1.1.3 Asynchronous communication

If the sensor is configured to asynchronous mode, the sensor operates with a defined data rate. The specified data message will be continuously transmitted from the sensor at fixed time intervals (t_{async}). In this mode, only one satellite can be connected per physical channel.

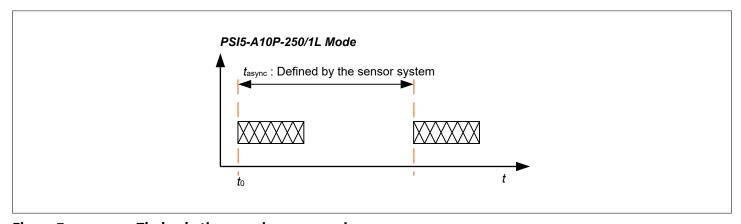


Figure 7 Timing in the asynchronous mode

4.1.2 Data link layer

4.1.2.1 PSI5 protocols

The data link layer is based on PSI5 specified modes described in the technical specification for a peripheral sensor interface [2].

The following modes are available (selectable by EEPROM bit):

Synchronous modes:

- PSI5-P10P-250/1L
- PSI5-P10P-250/2H single slot mode 1st or 2nd slot
- PSI5-P10P-500/3L single slot mode 1st or 2nd or 3rd slot
- PSI5-P10P-500/3L dual slot mode
- PSI5-P10P-500/3L triple slot mode (reduced VDD only; see Table 4)
- PSI5-P10P-500/4H single slot mode 1st or 2nd or 3rd or 4th slot
- PSI5-P10P-500/4H dual slot mode
- PSI5-P10P-500/4H triple slot mode
- PSI5-P16CRC-500/2L single slot mode 1st or 2nd slot
- PSI5-P16CRC-500/2L dual slot mode (reduced VDD only; see Table 4)

Technical product description



4 Functional block description

- PSI5-P16CRC-500/3H single slot mode 1st or 2nd or 3rd slot
- PSI5-P16CRC-500/3H dual slot mode

Asynchronous modes:

PSI5-A10P-250/1L

•

Note: Only the here specified protocols in combination with the operating modes specified in Chapter 1.2 are allowed and verified.

In multi slot mode, the sensor can transmit sensor information in several time slots. The user can select between the transmission of additional p_0 or T_j data or also between transmission of two $\Delta p/p_0$ data sets with different sensitivity. It is possible to select either p_0 or T_j data or to alternate between the two values for each transmission. For details please refer to the full version of the datasheet.

4.1.2.2 Data protocol (10-bit format)

The default data frame structure is defined by a 13-bit message format. The message consists of two (2) start bits, ten (10) data bits and one (1) parity bit (number of high bits in the binary data and parity value).

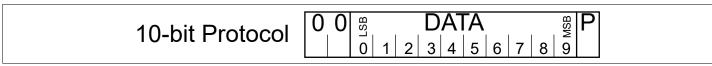


Figure 8 10-bit protocol (13-bit message)

The message bits are described in the table below:

Table 10 Data field 13-bit message

Message Bit	Definition	Logic Level	
0 1	start bit 1 and 2	0	
2 11	data bit 0 (LSB) data bit 9 (MSB)	0, 1	
12	parity (even)	0, 1	

4.1.2.2.1 Data range

The operation of the device is divided into four phases. Each phase will use its own data range for transmission of data from the sensor to the ECU. The figure below describes the separate data ranges of the 10-bit protocol (13-bit data message). For details on the four phases, please refer to Chapter 4.1.3.

Technical product description



4 Functional block description

	<u>o</u>			Phase 1	Pha	se 2	Phase 3	Phase 4	Phase 4	
	Range	dec	hex		2a	2b	3a 3b	dp/p0 data	p0 and T data	PSI5 test mode
		511	1FF			optional		пр/ро чата	po and i data	
							reserved	reserved	reserved	
		501	1F5							
		500	1F4			reserved	sensor defect	sensor defect	sensor defect	
	Status	499	1F3							reserved
2	& Error						reserved			
	Messages	489 488	1E9 1E8			sensor busy				
		487	1E7			concer bucy	sensor ready	reserved	reserved	
		482	1E2							error
		481	1E1							ОК
		480	1E0					∆p/p₀ maximum (Mode 2 & 3)	p ₀ = max	
			122					 Δp/p ₀ maximum		
		307	133		reserved			Δp/p₀ maximum (Mode 1)		
		1	001							
		0	000					$\Delta p/p_0 = 0\%$	p ₀ = min	
		-1	3FF						reserved	
	Sensor						reserved			
1	Output	-70	3BA						T _j = max	reserved
	Signal	-72	3B8					∆p/p₀ minimum (Mode 3)		
		-102	39A					Δp/p₀ minimum (Mode 1)		
				reserved				 Δp/po minimum		
		-307	2CD	(no data)				(Mode 2 & 3)		
		-425	257						T _j = min	
									,	
		-480	220			reserved		reserved		
		-481	21F		status 1111		nibble 11111		reserved	status 1111
		-492	214					protocol error	protocol error	
		-496	210		status 0000		nibble 10000			status 0000
		-497	20F		ID code 16		nibble 01111	reserved	reserved	ID code 16
		-498	20E		ID code 15		nibble 01110			ID code 15
		-499	20D		ID code 14		nibble 01101			ID code 14
		-500	20C		ID code 13		nibble 01100	sensor cell error	sensor cell error	ID code 13
3	Block ID's and	-501 -502	20B		ID code 12 ID code 11		nibble 01011	received	rosomiad	ID code 12
٦	Data for Initialization	-502	20A 209		ID code 11		nibble 01010	reserved	reserved	ID code 11
		-504	208		ID code 9		nibble 01000	signal chain error	signal chain error	ID code 9
		-505	207		ID code 8		nibble 00111			ID code 8
		-506	206		ID code 7		nibble 00110	reserved	reserved	ID code 7
		-507	205		ID code 6		nibble 00101			ID code 6
		-508	204		ID code 5		nibble 00100	p₀ init error	p₀ init error	ID code 5
		-509 -510	203		ID code 4		nibble 00011	reserved	reserved	ID code 3
		-510 -511	202		ID code 3		nibble 00010	p₀ out of range error	p₀ out of range error	ID code 3 ID code 2
		-512	200		ID code 1		nibble 00000	reserved	reserved	ID code 1
Ц	L									ı

Figure 9 Data content overview (10-bit protocol)



4 Functional block description

4.1.2.3 Data protocol (16-bit format)

When operating in 16-bit operating mode, the data frame structure is defined by a 21-bit message format. The message consists of two (2) start bits, two (2) serial channel bits, fourteen (14) data bits and three (3) CRC check bits.

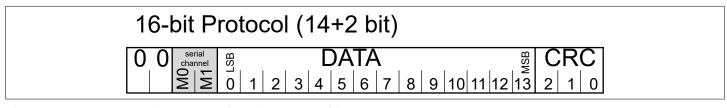


Figure 10 16-bit protocol (21-bit message) in Phase 4

The message bits are described below.

Table 11 Data field 21-bit message

Message Bit	Definition	Logic Level	
0 1	start bit 1 and 2	0	
23	serial channel bits	0, 1	
417	data bit 0 (LSB) data bit 13 (MSB)	0, 1	
18 20	CRC check bits (C2, C1, C0)	0, 1	

Note: The serial messaging channel is not used and the two bits are fixed to zero ("0").

4.1.2.3.1 CRC calculation

Error detection is realized by a three bit CRC, calculated from the full 16-bit payload bits (14+2 bits). The generator polynomial of the CRC is $g(x) = 1 + x + x^3$ with a binary CRC initialization value "111". Start bits are ignored in the CRC check. The three check bits are transmitted in reverse order (MSB first; C2, C1, C0).

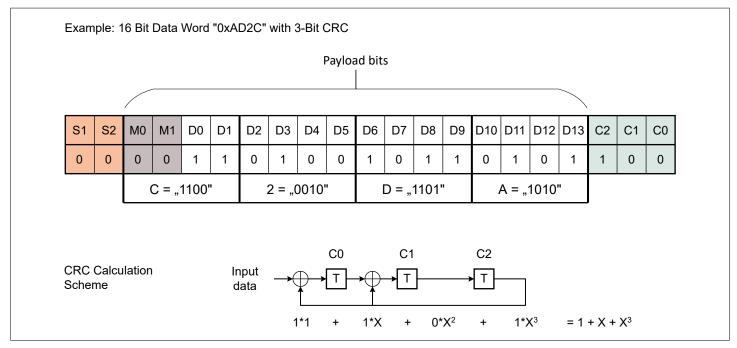


Figure 11 Example for CRC calculation



4 Functional block description

4.1.2.3.2 Data range scaling

During Phase 2 and Phase 3 as well as for error messages, the serial channel bits are not transmitted. Instead, the full 16-bit word is used to transmit data in the following format:

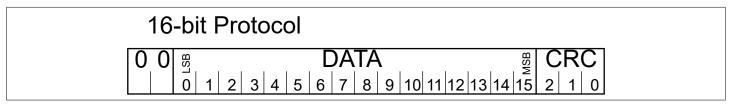


Figure 12 16-bit protocol (21-bit message) in Phase 2 and Phase 3

As data content, the 10-bit status and initialization words are used and extended to the 16-bit word by the following rule:

- The 10-bit word is transmitted in the MSB section of the 16-bit frame
- The 6 LSBs (D5 ... D0) are filled up with the value of the bit corresponding to the "D0" bit in the 10-bit data word.

This allows the possibility to check for stuck bits in the receiver. An example is shown below.

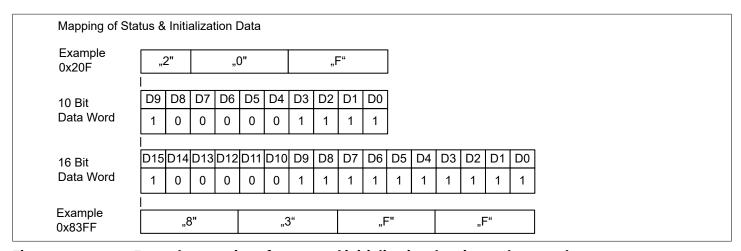


Figure 13 Example: mapping of status and initialization data into a data word

4.1.2.3.3 Data range

The operation of the device is divided into four phases. Each phase will use its own data range for transmission of data from the sensor to the ECU. The figure below describes the separate data ranges of the 16-bit protocol. For details on the four phases, please refer to Chapter 4.1.3.

Technical product description



4 Functional block description

Phase 1 Phase 2 Phase 3 Phase 4 dpt/p0 data										
Status +32000 0x7D00		ange	dec	hex	Phase 1					
Status +32000 0x7D00		Ra				∠a		за	3D	dp/p0 data
Status			+32767	0x7FFF						
2								rese	erved	reserved
2 Error Messages (16-bit)		Status	+32000	0x7D00			reserved	senso	r defect	sensor defect
1	2	Error Messages	:					rese	erved	
1		(16-bit)	+31232	0x7A00			sensor busy			
+30721 0x7801 +7680 0x1E00			+31231	0x79FF				senso	r ready	reserved
1 1 1 1 1 2 2 2 3 3 3 3 3 3 3										
1										
1										
App = 0% App = 10% App = 10%										Δp/p ₀ maximum
Sensor Output 1						reserved				
Sensor Output 1			+480	0x01E0						∆p/p₀ maximum (Mode 2 & 3)
Sensor										
1			+307	0x0133						∆p/p₀ maximum (Mode 1)
1 Output 1 Ox0001 O 0x0000 Coulomb Output Output								rese	erved	
(14-bit)	1		1	0x0001				1000	, vou	
-102 0x039A	ľ									∆p/p₀ = 0%
Block ID's and Data for Initialization (16-bit) -3256 0x8200		(14-bit)	-1	0x3FFF						
Block ID's and Data for Initialization (16-bit) -32256 0x8200					(no data)					Λρ/ρ₀ minimum
-307 0x3ECD -7680 0x2200 -30721 0x87FF31488 0x850031744 0x8400 -31745 0x83FF31745 0x83FF32000 0x830032256 0x820032512 0x810032641 0x807F -32768 0x8000 ID code 1 Aplipo minimum (Mode 2 & 3 & 4) reserved reserved nibble 11111 nibble 11111 nibble 11111 nibble 10000 reserved nibble 01111 reserved pp out of range error reserved pp out of range error nibble 00000 reserved			-102	0x039A						(Mode 1)
Block ID's and Data for Initialization (16-bit) -3256 0x8200							reserved			1
-7680 0x2200 reserved -7680 0x2200 status 1111 nibble 11111 -30721 0x87FF status 1111 nibble 11111 -31488 0x8500 -31744 0x8400 status 0000 nibble 10000 -31745 0x83FF -32000 0x8300 -32000 0x8300 -32256 0x8200 -32256 0x8200 -32512 0x8100 -32641 0x807F .32768 0x8000 ID code 1 nibble 00000 reserved			-307	UX3ECD						(Mode 2 & 3 & 4)
Status 1111										
Block ID's and Data for Initialization (16-bit) -32256 0x8200			-7680	0x2200						reserved
3 Block ID's and Data for Initialization (16-bit) -32256 0x8200			-30721	0x87FF		status 1111		nibble	11111	
Block ID's and Data for Initialization (16-bit) -32256 0x8200										
Block ID's and Data for Initialization (16-bit) -32000 0x8300 -32512 0x8100 -32512 0x8100 -32641 0x807F -32768 0x8000			-31488	0x8500						protocol error
Block ID's and Data for Initialization (16-bit) -32000 0x8300 -32256 0x8200										
Block ID's and Data for Initialization (16-bit) -32000 0x8300 -32256 0x8200 -32512 0x8100 -32512 0x807F										reserved
Data for Initialization						ID code 16		nibble	01111	
Initialization	,	Data for								cancer cell
(16-bit) -32256 0x820032512 0x810032512 0x810032641 0x807F -32768 0x8000 ID code 1 signal chain error reserved po init error reserved po out of range error	3									
-32512 0x8100 -32512 0x8100 -32641 0x807F -32768 0x8000 ID code 1 reserved po init error reserved po out of range error nibble 00000 reserved		(16-bit)								
-32512 0x810032641 0x807F -32768 0x8000 ID code 1 po init error reserved po out of range error nibble 00000 reserved										
-32641 0x807F -32768 0x8000 ID code 1 p ₀ out of range error nibble 00000 reserved										
-32768 0x8000 ID code 1 nibble 00000 reserved										
				-		ID code 1		nibble	00000	
	∟ Nr	ote: For data in		and 3 the	full 16-hit d	ata word is	used			

Figure 14 Data content overview (16-bit message)

Technical product description



4 Functional block description

4.1.3 PSI5 interface application layer

The following chapter describes the different operation phases of the device in detail.

4.1.3.1 Phase 1

During Phase 1 there is no data transmission.

- Duration: t_{P1}
- No reaction on sync pulses
- Reset and sensor self tests
- Initialization of the p_0 filter (start time is defined with $t_{p0_init_start}$ after internal reset, duration: t_{p0_init}). After the initialization, the decrement / increment filter for p_0 calculation is internally clocked.
- Check for the entry key of the PSI5 test mode.
- Check for test mode entry key, set via SPI command.

Only during Phase 1 it is possible to enter the PSI5 test mode. In order to do this, the ECU has to send a predefined entry key sequence. After successful entry into the PSI5 test mode, the sensor will not continue with Phase 2, but stay in this mode until a reset is issued from the ECU. For details about the PSI5 test mode, please refer to the full version of the datasheet.

Note: A reset from the ECU can be triggered by cycling the voltage on the VDD-pin.

4.1.3.2 Phase 2

During Phase 2 the sensor transmits identification tests and runs internal self tests

- Duration: t_{P2a} + t_{P2b}
- Phase 2a: Transmission of sensor identification data; repetition of ID data: k
- Phase 2b: based on the test result of the p_0 filter initialization test

Additional information about phase 2b is given in the full version of the datasheet.

4.1.3.2.1 Identification data content

During Phase 2a the sensor transmits identification data. The data blocks correspond to D1...D32 as given in the PSI5 standard.

Table 12 Phase 2a data content

Data Field	Identifier	Data block	Parameter	Content	Value	Comment
F1	PSI5 protocol version	D1	PSI5 spec	V1.3 or V2.1	xxxx	V1.3 is pre-programmed, but is re-programmable by the customer
F2	number of data blocks	D2, D3	number of blocks	32 * 4-bit data blocks	0010 0000	fixed in ROM
F3	satellite manufacturer code 1	D4, D5	satellite manufacturer code 1	customer programming	xxxx xxxx	customer programmable
F4	sensor type	D6	sensor type	pressure sensor	xxxx	customer programmable
	continuos	D7			1000 _b	fixed for $\Delta p/p_0$ data in sense _{out1}

Technical product description



4 Functional block description

Table 12 (continued) Phase 2a data content

Data Field	Identifier	Data block	Parameter	Content	Value	Comment
					1100 _b	fixed for Δp/p ₀ data in sense _{out2}
					xxxx	customer programmable for p ₀ or T _j data
F5	sensor parameter	D8, D9	sensor parameter	customer specific parameters	xxxx xxxx	customer programmable
F6	satellite manufacturer code 2	D10, D11	satellite manufacturer code 2	sensor specific definition	xxxx xxxx	customer programmable
F7	sensor code	D12- D14	sensor code	AK-wide defined device index	xxxx xxxx xxxx	customer programmable
F8	production date	D15	year	Yn: 7 bit (099)	Y6 Y5 Y4 Y3	supplier production date
		D16	year / month	Mn: 4 bit (112)	Y2 Y1 Y0 M3	is pre-programmed, but is re-programmable by
		D17	month / day	Dn: 5 bit (131)	M2 M1 M0 D4	the customer
		D18	day		D3 D2 D1 D0	
F9	serial number	D19- D20	serial number	IFX line/lot/serial number	0000 0000	fixed
		D21- D32			xxxx	programmed and locked by the supplier

Note:

In multi slot mode, each time slot sends its own ID data. They are identical for each sync pulse and differ only in field D7.

The field F9 contains an unique serial number for each sensor and allows complete tracing of the sensor.

This serial number is different from all previous SAB sensor devices (e.g. KP106 ... KP109, KP20x, KP30x). The device can be identified by the product-ID in nibble D24.

Table 13 Product IDs (D24)

Product name	Product ID
KP405	0010 _b

4.1.3.3 Phase 3

During phase 3, the sensor transmits diagnostics data.

- Duration: t_{P3a} + t_{P3b}
- Phase 3a: send status information "sensor ok" (0x1E7) or error sequence (sensor defect (0x1F4) and error classification frame)
- Phase 3a: p₀ transmission
- Phase 3b is optional: Transmission of sensor specific diagnosis data (more information about phase 3b can be found in the full version of the datasheet)



4 Functional block description

With the 1st frame during Phase 3a the sensor transmits sensor ready (OK, 0x1E7) or in case of a detected error the error sequence (see Chapter 4.1.3.5). The decision about the sensor status is based on the test results done before. If no error is detected, the next 4 frames transmit the p_0 word p_3 value (12 bit value, separated in four 5 bit nibbles).

Table 14 Phase 3a data content

Frame No.	Normal operation		Error	Error		
	Function	Code	Function	Code		
1	Sensor ready	0x1E7	Sensor defect	0x1F4		
2	nibble 0	0x200 0x207	Error Code	0x20x		
3	nibble 1	0x208 0x20F	Sensor defect	0x1F4		
4	nibble 2	0x210 0x217	Error Code	0x20x		
5	nibble 3	0x218 0x21F				

4.1.3.3.1 Ambient pressure transmission structure

The p_0 word p_3 is defined as follows and based on the output of the p_0 filter.

$$\begin{aligned} p_{0_word_p3} &= d_{11} \ d_{10} \ d_{9} \ d_{8} \ d_{7} \ d_{6} \ d_{5} \ d_{4} \ d_{3} \ d_{2} \ d_{1} \ d_{0} \\ nibble_{0} &= 0 \ 0 \ d_{11} \ d_{10} \ d_{9} \\ nibble_{1} &= 0 \ 1 \ d_{8} \ d_{7} \ d_{6} \\ nibble_{2} &= 1 \ 0 \ d_{5} \ d_{4} \ d_{3} \\ nibble_{3} &= 1 \ 1 \ d_{2} \ d_{1} \ d_{0} \end{aligned}$$

Figure 15 p_{0 word p3} definition

4.1.3.4 Phase 4

During normal operation the $\Delta p/p_0$ output value is transmitted via the PSI5 interface. If the normalized relative pressure $(\Delta p/p_0)$ under- or overshoots the measurement range (range_{nomx}), the $\Delta p/p_0$ value is clipped to the minimum/maximum allowed $\Delta p/p_0$ output value $(\Delta p/p_{0_datx})$. The limit and value depends on the selected operating mode.

In case p_0 is out-of-range or if an error is detected, which still allows Manchester communication, the error sequence is sent. Details see Chapter 4.1.3.5.

Note:

As long as the sensor transmits Manchester data, the data is inside the specified range. No incorrect data will be sent, even in the range between the operating voltage and the reset voltage level.

Depending on the selected protocol mode the actual p_0 value or the junction temperature T_j will be transmitted in an additional time slot, in parallel to the $\Delta p/p_0$ value. If the values are outside the output range, the values are clipped to the minimum/maximum allowed output values ($T_{word_p4_lim}$ or $p_{0_word_p4_lim}$).

$$p_0 = 8 \times p_{0_word_p4} \times p_{0_sens_rx} + p_{0_offset}$$

Figure 16 Formula for p0 data in phase 4

$$T_j = (T_{word_p4} + 512) \times T_{j_sens} + T_{j_offset}$$

Figure 17 Formula for T_i data in phase 4

infineon

4 Functional block description

4.1.3.5 Error sequence

In case of a detected error and Manchester communication is still enabled, the error sequence is sent in Phase 3 and Phase 4. The error sequence consists of the following two frames:

- 1st frame: "Sensor defect" message (0x1F4)
- 2nd frame: Error code (see more information in the full version of the datasheet)

This error sequence is sent until a power down is triggered. In case of more than one error at the same time, only the error with the highest priority is reported in the PSI5 error sequence.

4.2 Micro break functionality

The micro break control is optional and can be achieved by connecting an external buffer capacitor to the CAP pin of the device. This buffer capacitor provides energy for correct operation during micro breaks. The capacitor is charged to maximum $V_{DD} - V_{drop}$. The load current for the buffer capacitor is limited by the resistor R_{CAP} .

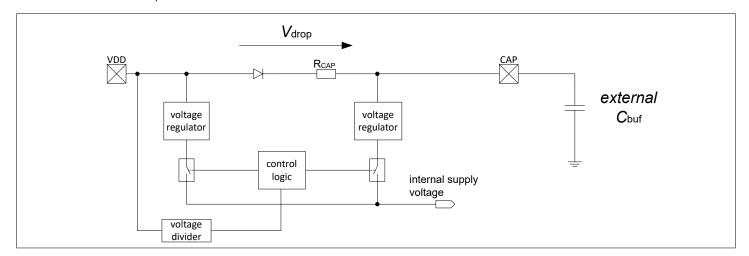


Figure 18 Simplified block level diagram for micro break functionality

A diode prohibits current from conducting into the wrong direction, possibly interfering with the data transmission. The micro break control is part of the voltage regulator concept.

As long as the sensor transmits Manchester data, the data is inside the specified range. No incorrect data will be sent, even in the range between the operating voltage and the reset voltage level.

The size of the capacitor depends on the required micro break timing $t_{\mu b}$ and can be calculated by the following formula:

$$t_{\mu b} = \frac{(VDD - V_{drop} - V_{\mu b_drop}) \cdot C_{buf}}{I_{VDD}}$$

Figure 19 Formula for micro break time calculation

The micro break function is activated when the voltage on the V_{DD} pin is below $V_{\mu b}$. Then the voltage regulator is supplied from the C_{buf} capacitor.

In the synchronous mode the sync pulse voltage is also used to charge the buffer capacitor. Therefore the buffer capacitor's charge is higher than in the asynchronous mode, where only the supply voltage is provided. The given formula is not considering the additional charge by the sync pulse, this formula is only valid for a direct current supply. The influence of the sync pulse charging the buffer capacitor depends on the sync pulse duration and voltage level, as well as the type of buffer capacitor used and the internal resistance of the capacitor. Therefore, a formula is not given.

Technical product description



4 Functional block description

Manchester modulation is interrupted during the active micro break mode. The energy of the buffer capacitor is not spend for the Manchester modulation. As soon as V_{DD} returns to normal operating conditions, the current modulator starts working immediately.

If the ECU wants to force a reset of the sensor, the voltage on the supply pin must be hold below $V_{\mu b_min}$ for a time longer than t_{ub} .

4.3 Test modes

The device has two different test modes:

- The PSI5 test mode is the main customer interface to program the EEPROM during production.
- The SPI test mode is used by Infineon only.

Entry into test mode is only possible during Phase 1. While being in test mode, no normal sensor operation is possible and the sensor will stop sending $\Delta p/p_0$ data.



5 Application information

5 Application information

5.1 Potential target applications

The device is used to detect the pressure change inside a door during a side crash, in tube systems used for pedestrian protection- or front crash detection systems and other similar applications.

5.2 Application circuit example

The capacitors C_1 and C_2 have to be placed as close to the device as possible. Any long distances may have an influence on the EMC performance. C_{buf} is only necessary to prevent voltage loss during micro breaks.

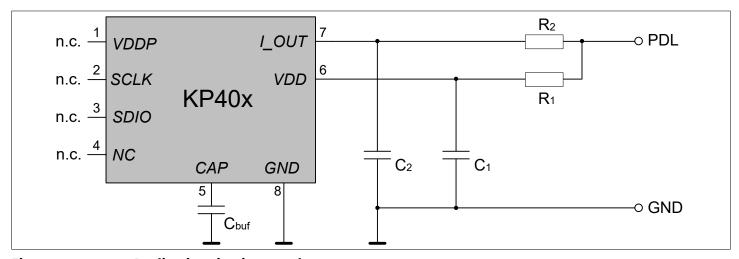


Figure 20 Application circuit example

The digital pins (VDDP, SCLK, SDIO) have an internal pull-up or pull-down resistor (R_{pu} , R_{pd}) and therefore normal operation must be with floating pins (in case of an open GND wire, the floating pins prevent from a cross grounding through the corresponding ESD diodes). The traces should be spaced sufficiently to avoid shorts between the serial interface and the high voltage pins of the device.

To avoid overheating of the sensor, a maximum temperature difference from sensor-ambient to module-ambient of $T_{rise\ mod}$ has to be ensured by the satellite design.

Table 15 Application circuit components

Component	Value	Unit	Tolerance
$\overline{R_1}$	47	Ω	+/-5%
$\overline{R_2}$	47	Ω	+/-5%
$\overline{C_1}$	15	nF	+/-20%
$\overline{C_2}$	2.2	nF	+/-20%
C _{buf}	see Table 5		

5.3 Electro magnetic compatibility (EMC)

The device is characterized according to the EMC requirements described in the "Generic IC EMC Test Specification" [7].

System EMC performance on system level is dependent on the module design and the ECU implementation. The device is capable to pass the system tests according to the AK-LV - EMC specification [8] with the application circuit defined in Chapter 5.2.



6 Package information

6 Package information

For passivation the sensor die is covered with a transparent silicone gel. Bubbles adjacent to the bond wires are not allowed (delivery status). The bond wires will be completely covered by gel. The surface of the gel is smooth. The sensor package is compliant to RoHs.

6.1 Package outline

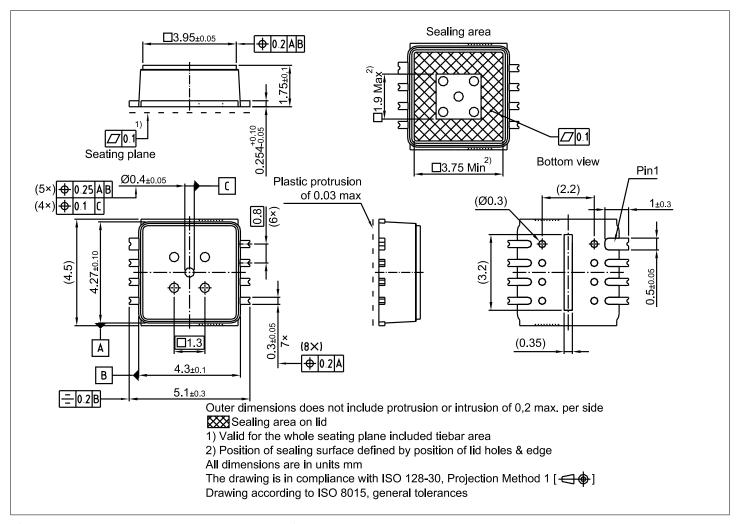


Figure 21 PG-DFN-8-1 package outline



6 Package information

6.2 Package footprint drawing

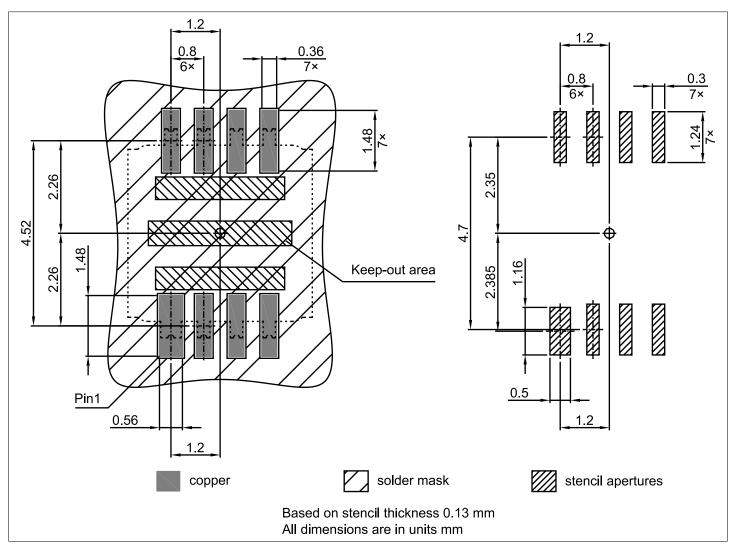


Figure 22 PG-DFN-8-1 package footprint drawing

6.3 Pick and place info

The following chapter gives information about the pick and place capability of the PG-DFN package. Detailed information can be found in an additional document including board assembly recommendations [12].

6.3.1 Component placement

Although the self-alignment effect due to the surface tension of the liquid solder will support the formation of reliable solder joints, the components have to be placed accurately according to their geometry. Manual positioning of the package is not recommended, but it is possible.

For the PG-DFN package with a pad width of 0.3 mm and a pitch of 0.8 mm, an automatic pick-and-place machine is recommended to achieve reliable solder joints.

The device is delivered in tape and reel packing which is suitable for being used in pick-and-place equipment.

The pressure difference between the inside and the outside of the package should not exceed p_{diff} (see Table 3).



6 Package information

6.4 Identification code

The identification code for the device is on the same side of the package as pin 1.

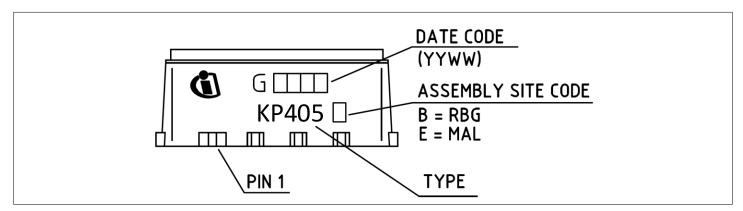


Figure 23 Identification code for KP405

Technical product description



7 References

7 References

Table 16 References

Number	Bibliography
[1]	PSI5 Specification, V1.3, 29.07.08
[2]	PSI5 Specification, V2.1, 08.10.2012
[3]	PSI5 Substandard Airbag, V2.1, 05.10.2012
[4]	AK-LV 29, V1.4, 03/2011, "Standard AK-Pressure Sensors for Crash Detection"
[5]	AK-LV 38, V1.0, 13.02.2014, "Druckbasierter Aufprallsensor"
[6]	AK-LV 38 Addendum, Zusatzblatt_20161021_entwurf.pdf, Draft-Version 21.10.2016
[7]	BISS, "Generic IC EMC Test Specification", Version 1.0, July, 6th 2004
[8]	AK-LV 27 / AK-LV 29, Part 3 "EMC Requirements", V2.06, March, 9th 2011
[9]	Siemens Norm SN 29500-2, Edition 2010-09, Siemens AG Munich
[10]	Declaration of Compliance to the RoHS Directive for Infineon "Green Products", MatQ-2013-103-RoHS, Nov. 2013
[11]	ISO 26262, Vehicles Functional Safety, Version 2018
[12]	Recommendations for board assembly of Infineon pressure sensor packages for automotive applications, Revision 1.0, Infineon Technologies AG

Technical product description



8 Revision history

8 Revision history

Table 17 Revision history

Revision number	Date of release	Description of changes
1.0	2025-01-31	 Initial release of technical product description extracted from the datasheet of KP405, Rev. 1.10

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2025-01-31 Published by Infineon Technologies AG 81726 Munich, Germany

© 2025 Infineon Technologies AG All Rights Reserved.

Do you have a question about any aspect of this document?

 ${\bf Email: erratum@infineon.com}$

Document reference IFX-mhf1736500090269

Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.